

Session III

Commercial MMIC Applications I

Chairman:

S. Moghe
Northrop ESD

Co-Chairman:

I. Bahl
ITT/GTC

This session discusses a number of papers addressing commercial applications like personal and mobile communications, direct broadcast satellite and instrumentation. The three GaAs technologies considered are MESFET, HBT and HEMT. Major activities are in reducing chip size and cost, lowering prime power consumption, and operating at low bias voltages. The circuits discussed include low noise and power amplifiers, transceivers and switches.

1:30 p.m.–3:10 p.m., Monday, June 14, 1993
Congress Center Room 313

